SENSOR DEVELOPMENTS (BeamCal)

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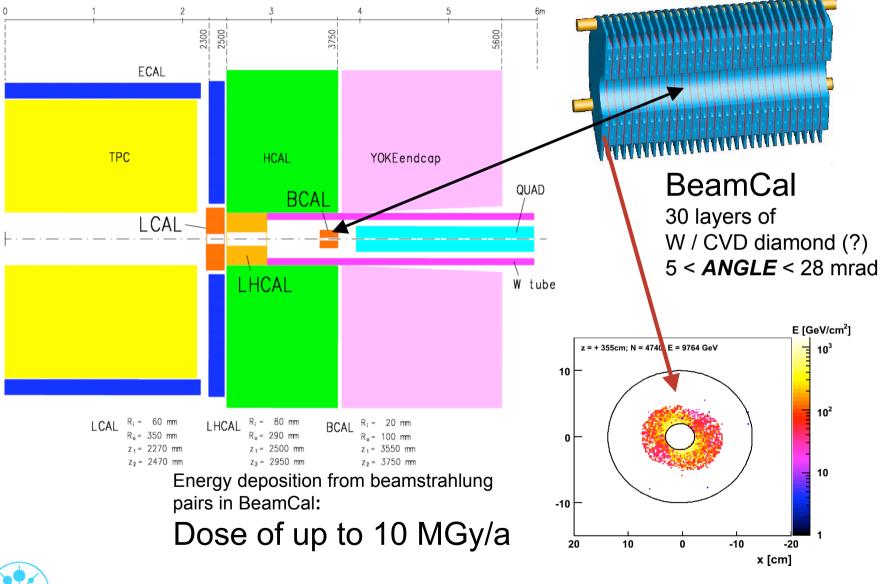


OUTLINE OF THIS TALK

- 1. Introduction
- 2. Silicon
- 3. CVD Diamonds
- 4. Gallium Arsenide
- 5. Silicon Carbide
- 6. Conclusions



INTRODUCTION



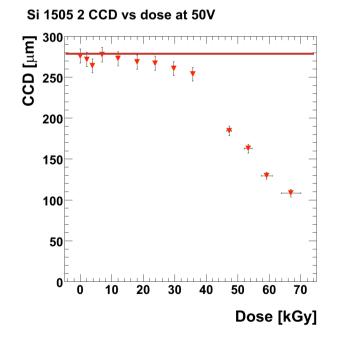


SILICON

- operated as 'extended' pn junction -> depleted intrinsic material (bandgap 1.12 eV)
- The only material which is fully 'under control': *reference material*
 - technology: availability, structuring, testing, assembly
 - properties: signal yield, stability, long term behaviour
- Problem: radiation hardness:

Sample irradiated with e⁻: Thickness = 280 µm Initial CCD = 280 µm (100% collection efficiency)

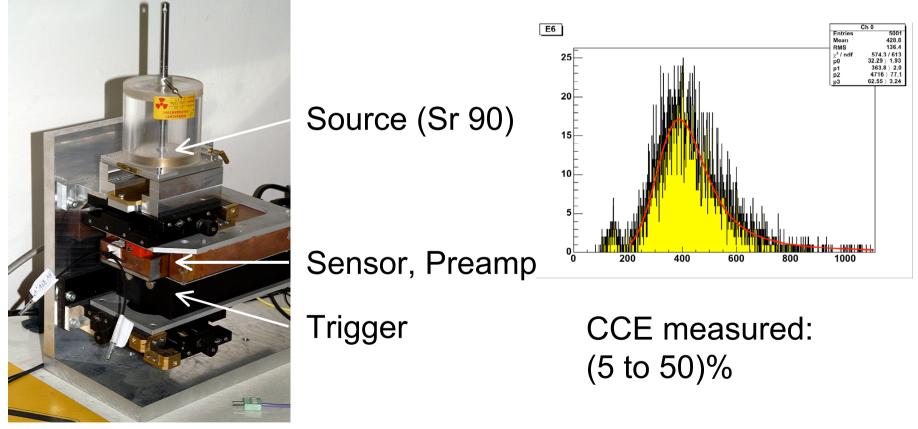
- will improve significantly
- still not sufficient for the inner radii of a planned BeamCal





CVD DIAMONDS - polycrystalline (1)

- operated as 'solid state ionization chamber' (bandgap ~ 5.5 eV)
- different sources: IAF (Fraunhofer, Freiburg), E6
- state of the art: 4" wafers, 6" possible -> sensor areas > $50 \times 50 \text{ mm}^2$
- structuring by metallization ('coarse patterns') w/o photolithography

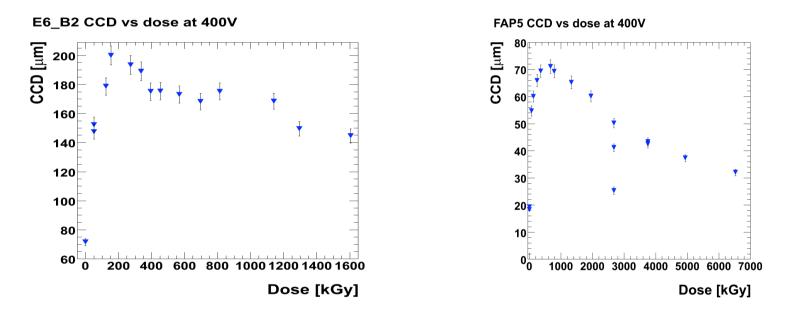




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CVD DIAMONDS - polycrystalline (2)

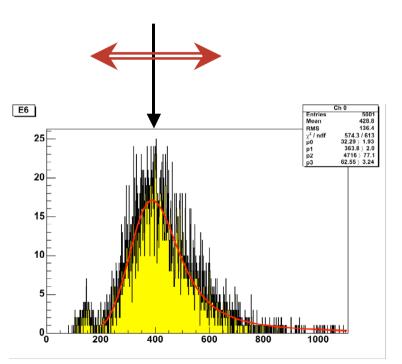
- radiation hard (survival) but no stable and no predictible behaviour:
 - dependence of CCD on dose acquired (pumping / degradation)



- dependence on pumping and degradation, on dose rate applied
- changes (vs irrad) observed: improvement, degradation
- actual properties time dependent (relaxation, recovery)

CVD DIAMONDS - polycrystalline (3)

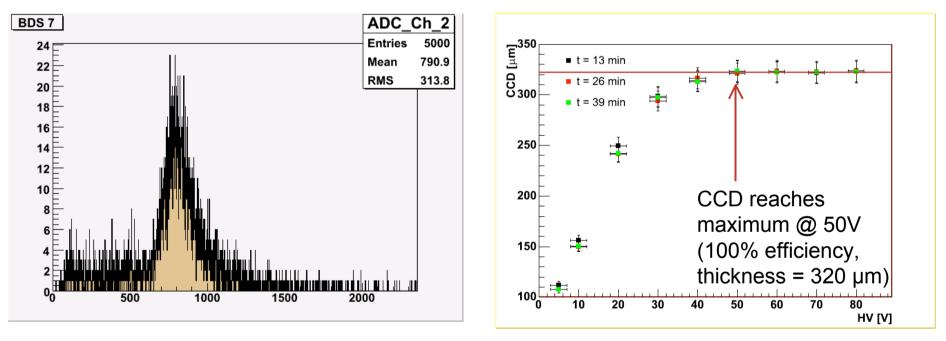
- signal yield depends on
 - material (sample)
 - conditioning (history, pumping, dose acquired)
 - actual conditions (dose rate)
- applications w/o threshold: spectrometry
 - instant recalibration necessary
- applications with thresholds counting





CVD DIAMONDS - single crystals (1)

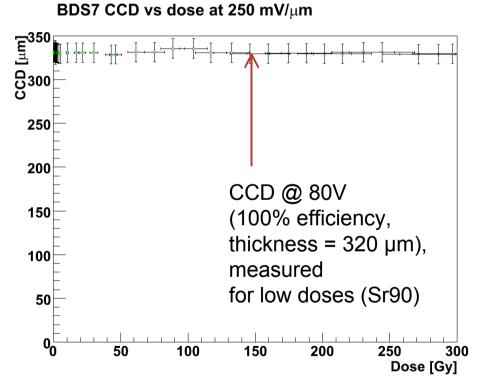
- Single Crystal (CVD grown on substrate) by E6
- Size: $5 \times 5 \text{ mm}^2$, metallization 3 mm in diameter, $320 \mu \text{m}$ thick

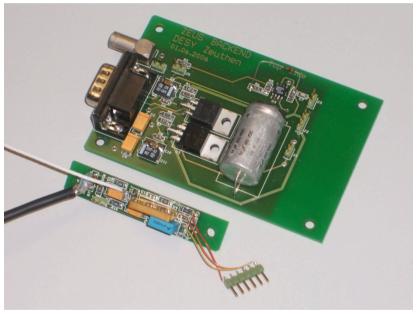


- Clearly separated spectrum of minimal ionizing particles
- 100% CCE, CCD = thickness, 1 mip results in 11.5 ke⁻ (1.84 fC)

CVD DIAMONDS - single crystals (2)

• Stable for low doses, further investigations needed (and planned)

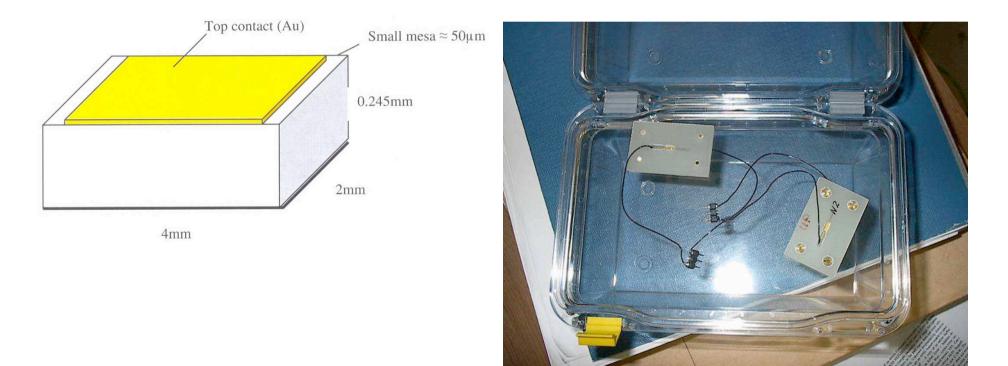






Gallium Arsenide (1)

- operated as
 - 'solid state ionization chamber' (bandgap: 1.42 eV) or as
 - 'extended pn junction': p-i-n structure



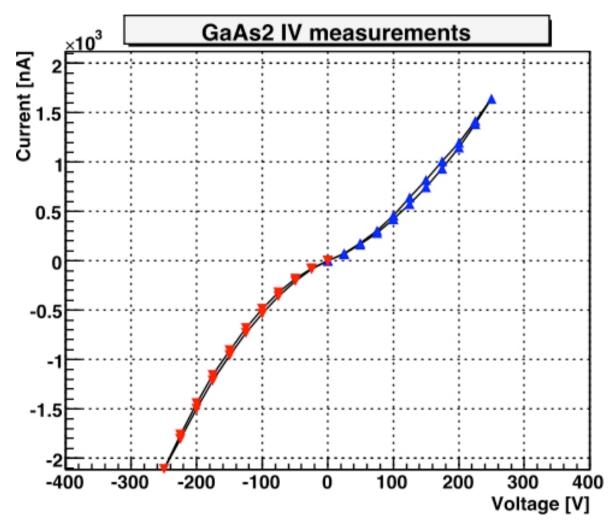


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Gallium Arsenide (2)

• static measurements (I/V)

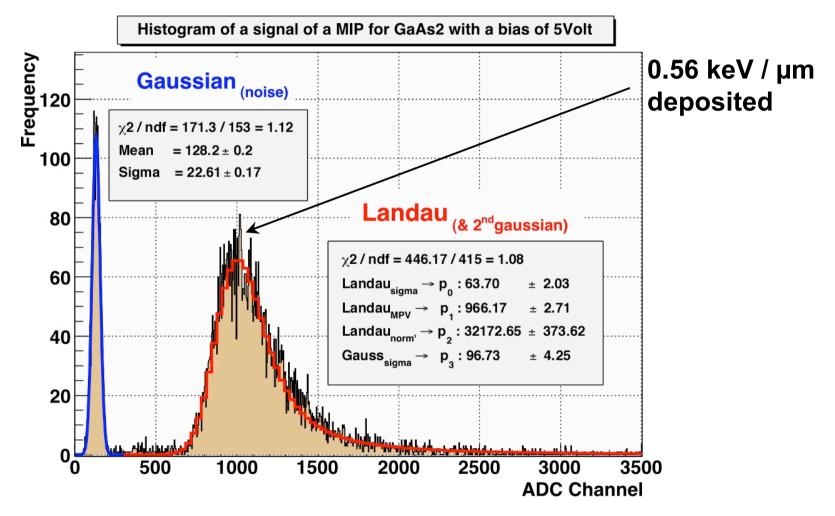
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Gallium Arsenide (3)

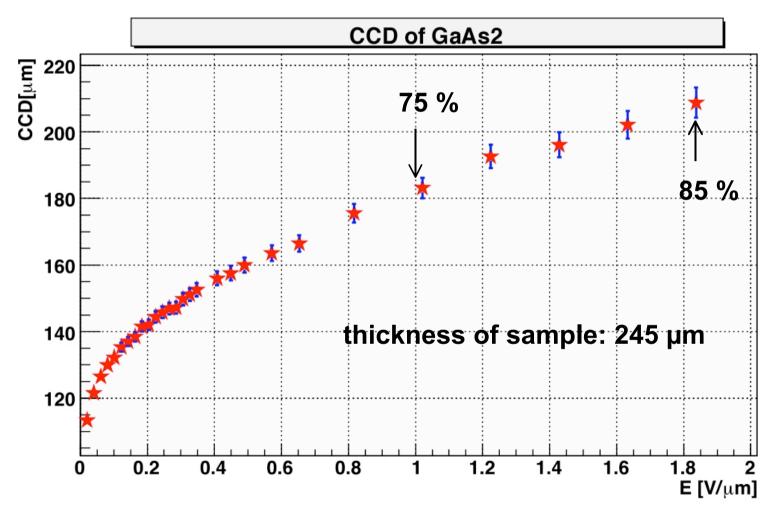
• Spectroscopic measurements (Sr 90)





Gallium Arsenide (4)

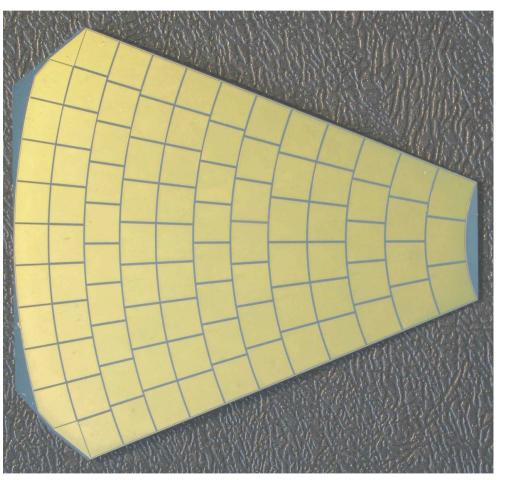
• Spectroscopic measurements (Sr 90) vs. voltage -> CCD





Gallium Arsenide (5)

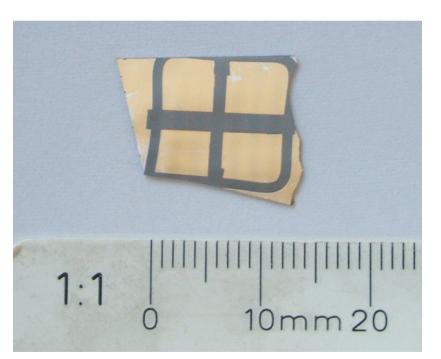
- first detector sample with BeamCal geometry (Dubna)
- we're looking forward to investigating these samples





Silicon Carbide (1)

- wide bandgap material: ~ (3...3.35) eV
 - -> solid state ionization chamber
- normally produced as epi layer (CVD) on silicon (industry!)
- SiC at wafer scale up to 75 mm (3")
- still high defect densities (15 to 30 'micropipes' per cm²)
- cost per cm²: (150 ... 300) Euro
- metal deposition ->
 - Schottky contact
 -> annealing @ high T -> ohmic contacts
- planned collaboration with BTU Cottbus





CONCLUSIONS

- harsh environment (irradiation) demand new detector materials
- current silicon does not survive the high radiation levels
 - but it's still got potential for improvement (LHC, X-ray etc)
 - watch the development
- GaAs: growing knowledge and experience (LHC etc)
 - promising detector capabilities
 - samples to be investigated
- CVD diamonds survive high doses
 - current samples are not (long term) stable (as detectors)
 - recommended only for counting applications
- Silicon Carbide has promising radiation hardness (literature)
 - already used by industry (power and high voltage devices)
 - detection properties to be measured...

